

IN THE
UNITED STATES PATENT AND TRADEMARK OFFICE

Inventor(s): Buswell et al.

Confirmation No.: 9361

Application No.: 10/080,747

Examiner: Do, A.

Filing Date: 02/22/2002

Group Art Unit: 2853

Title: A Slotted Semiconductor Substrate Having Microelectronics Integrated Thereon

Commissioner for Patents
PO Box 1450
Alexandria, VA 22313-1450

TRANSMITTAL LETTER FOR RESPONSE/AMENDMENT

Sir:

Transmitted herewith is/are the following in the above-identified application:

- (X) Response/Amendment () Petition to extend time to respond
(X) New fee as calculated below () Supplemental Declaration
() No additional fee (Address envelope to "Mail Stop Non-Fee Amendment")
(X) Other: Information Disclosure Statement; PTO Form 1449 (fee)

CLAIMS AS AMENDED BY OTHER THAN A SMALL ENTITY						
(1) FOR	(2) CLAIMS REMAINING AFTER AMENDMENT	(3) NUMBER EXTRA	(4) HIGHEST NUMBER PREVIOUSLY PAID FOR	(5) PRESENT EXTRA	(6) RATE	(7) ADDITIONAL FEES
TOTAL CLAIMS	32	MINUS	39	= 0	X \$18	\$ 0
INDEP. CLAIMS	4	MINUS	3	= 1	X \$86	\$ 86
[] FIRST PRESENTATION OF A MULTIPLE DEPENDENT CLAIM					+ \$290	\$ 0
EXTENSION FEE	1ST MONTH \$110.00	2ND MONTH \$420.00	3RD MONTH \$950.00	4TH MONTH \$1480.00		\$ 0
OTHER FEES						\$
TOTAL ADDITIONAL FEE FOR THIS AMENDMENT						\$ 86

Charge \$ 86 to Deposit Account 08-2025. At any time during the pendency of this application, please charge any fees required or credit any overpayment to Deposit Account 08-2025 pursuant to 37 CFR 1.25. Additionally please charge any fees to Deposit Account 08-2025 under 37 CFR 1.16 through 1.21 inclusive, and any other sections in Title 37 of the Code of Federal Regulations that may regulate fees. A duplicate copy of this sheet is enclosed.

"Express Mail" label no. EV316935724US

Date of Deposit 11/17/2003

I hereby certify that this is being deposited with the United States Postal Service "Express Mail Post Office to Addressee" service under 37 CFR 1.10 on the date indicated above and is addressed to: Commissioner for Patents, Alexandria, VA 22313-1450.

By

Typed Name: Carlin Taylor

Respectfully submitted,

Buswell et al.

By

Paul W. Mitchell

Attorney/Agent for Applicant(s)

Reg. No. 44,453

Date: 11/17/2003



IN THE UNITED STATES
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10 **To:** Commissioner of Patents and Trademarks
PO Box 1450
Alexandria, VA 22313-1450

15 **From:** Dmitry Milikovsky
Hewlett-Packard Development Company, L.P
Intellectual Property Administration
P.O. Box 272400
Fort Collins, Colorado 80527-2400

20 INTRODUCTORY COMMENTS

This communication is in response to the Office Action dated 8/15/03, for
which a three-month shortened statutory period for response is set for 11/15/03.

Please amend the above-identified application in accordance the directions set
forth below.

25 **Amendment to the Claims** are reflected on the list of claims which
begins on page 2 of this paper.

Remarks/Arguments begin on page 12 of this paper.

11/20/2003 SSESHE1 00000148 082025 10080747

01 FC:1201 86.00 DA

